



As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled **POWER CONTROL DEVICE WITH SEMICONDUCTOR CHIPS MOUNTED ON A SUBSTRATE**; the application for which was filed on **December 12**, 2001 as U.S. Patent Application No. 10/022,297; which application was amended by a *Response to September 12*, 2002 Office Action and a Request for Approval of Drawing Change submitted on December 12, 2002; and which application is being amended by a Response to March 11, 2003 Office Action, a copy of which is attached hereto;

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims, as amended by the amendments and the drawing change referred to above;

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56;

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

PRIOR FOREIGN APPLICATION(S)

Priority Claim d

 No.: 2000-379567
 Country: Japan
 Date Filed: 12/14/00
 Yes

 No.: 2000-379569
 Country: Japan
 Date Filed: 12/14/00
 Yes

 No.: 2001-052498
 Country: Japan
 Date Filed: 02/27/01
 Yes

POWER OF ATTORNEY: I hereby appoint the registrants of Knobbe, Martens, Olson & Bear, LLP, 620 Newport Center Drive, Sixteenth Floor, Newport Beach, California 92660, Telephone (949) 760-0404, Customer No. 20,995, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith (if this application is assigned, I acknowledge that the appointed individuals do not represent me, and that instead they represent the assignee).

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful, false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor: Koji Morita

Inventor's signature // Morita

Date / 02 / 2003

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Full name of third inventor: Takao Yoshikawa Inventor's signature Takao Yoshikawa Date 0b/02/2003 Residence: 2500 Shingai, Iwata, Shizuoka 438-8501, JAPAN Citizenship: Japan	
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